

Title (en)

SUBSTRATE HOLDER AND METHOD FOR PRODUCING A SUBSTRATE HOLDER FOR BONDING

Title (de)

SUBSTRATHALTER UND VERFAHREN ZUR HERSTELLUNG EINES SUBSTRATHALTERS ZUM BONDEN

Title (fr)

SUPPORT DE SUBSTRAT ET PROCÉDÉ DE FABRICATION D'UN SUPPORT DE SUBSTRAT POUR LA LIAISON

Publication

EP 4285402 A1 20231206 (DE)

Application

EP 21703193 A 20210201

Priority

EP 2021052267 W 20210201

Abstract (en)

[origin: WO2022161636A1] The invention relates to a substrate holder, a bonding device, a method for producing a substrate, and a bonding method.

IPC 8 full level

H01L 21/67 (2006.01); **H01L 21/18** (2006.01); **H01L 21/20** (2006.01); **H01L 21/687** (2006.01)

CPC (source: EP KR US)

H01L 21/185 (2013.01 - KR US); **H01L 21/67092** (2013.01 - EP KR US); **H01L 21/6875** (2013.01 - EP KR US); **H01L 21/185** (2013.01 - EP); **H01L 21/2007** (2013.01 - EP)

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

Designated validation state (EPC)

KH MA MD TN

DOCDB simple family (publication)

WO 2022161636 A1 20220804; CN 116457916 A 20230718; EP 4285402 A1 20231206; JP 2024510060 A 20240306; KR 20230134463 A 20230921; TW 202236494 A 20220916; TW I821880 B 20231111; US 2023369095 A1 20231116

DOCDB simple family (application)

EP 2021052267 W 20210201; CN 202180073042 A 20210201; EP 21703193 A 20210201; JP 2023526353 A 20210201; KR 20237014896 A 20210201; TW 111102845 A 20220124; US 202118031084 A 20210201